



## TPS8267x 600-mA, High-Efficiency MicroSiP™ Step-Down Converter (Profile <1.0mm)

### 1 Features

- 90% Efficiency at 5.5 MHz Operation
- 17µA Quiescent Current
- Wide  $V_{IN}$  Range From 2.3 V to 4.8 V
- 5.5MHz Regulated Frequency Operation
- Spread Spectrum, PWM Frequency Dithering
- *Best in Class* Load and Line Transient
- $\pm 2\%$  Total DC Voltage Accuracy
- Automatic PFM/PWM Mode Switching
- Low Ripple Light-Load PFM Mode
- $\geq 35\text{dB}$   $V_{IN}$  PSRR (1kHz to 10kHz)
- Internal Soft Start, 120-µs Start-Up Time
- Integrated Active Power-Down Sequencing (Optional)
- Current Overload and Thermal Shutdown Protection
- Sub 1-mm Profile Solution
- Total Solution Size  $< 6.7\text{ mm}^2$

### 2 Applications

- Cell Phones, Smart-Phones
- Camera Module, Optical Data Module
- Wearable Electronics
- Digital TV, WLAN, GPS and Bluetooth™ Applications
- POL Applications

### 3 Description

The TPS8267x device is a complete 600mA, DC/DC step-down power supply intended for low-power applications. Included in the package are the switching regulator, inductor and input/output capacitors. No additional components are required to finish the design.

The TPS8267x is based on a high-frequency synchronous step-down dc-dc converter optimized for battery-powered portable applications. The MicroSiP™ DC/DC converter operates at a regulated 5.5-MHz switching frequency and enters the power-save mode operation at light load currents to maintain high efficiency over the entire load current range.

The PFM mode extends the battery life by reducing the quiescent current to 17µA (typ) during light load operation. For noise-sensitive applications, the device has PWM spread spectrum capability providing a lower noise regulated output, as well as low noise at the input. These features, combined with high PSRR and AC load regulation performance, make this device suitable to replace a linear regulator to obtain better power conversion efficiency.

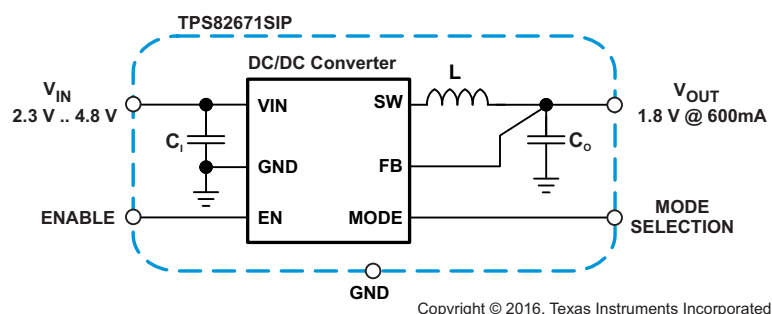
The TPS8267x is packaged in a compact (2.3mm x 2.9mm) and low profile (1.0mm) BGA package suitable for automated assembly by standard surface mount equipment.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE  | BODY SIZE (NOM) |
|-------------|----------|-----------------|
| TPS8267x    | µSiP (8) | 2.30 x 2.90 mm  |

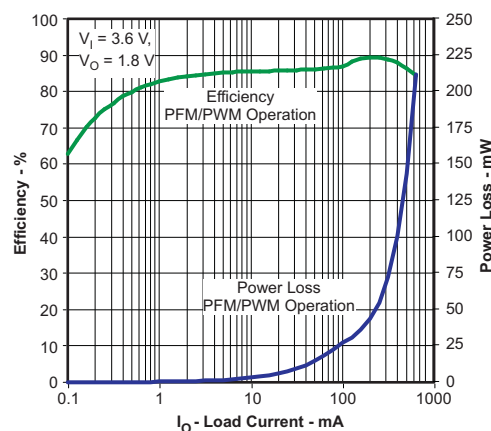
(1) For all available packages, see the orderable addendum at the end of the datasheet.

### 4 Simplified Schematic



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#### Efficiency vs Output Current



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## 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

|                                                                                                                                                                                                                                                                                                                         |             |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| <b>Changes from Revision I (November 2014) to Revision J</b>                                                                                                                                                                                                                                                            | <b>Page</b> |
| • Added TPS8267195 part number to data sheet .....                                                                                                                                                                                                                                                                      | <b>1</b>    |
| • Added TPS8267195 to Electrical Characteristics table .....                                                                                                                                                                                                                                                            | <b>7</b>    |
| • Changed Layout Example figure, Note 4 value from "...less than 0.5 mm.." to "...less than 0.5 µm.." .....                                                                                                                                                                                                             | <b>21</b>   |
| <b>Changes from Revision H (October 2014) to Revision I</b>                                                                                                                                                                                                                                                             | <b>Page</b> |
| • Moved T <sub>stg</sub> spec to Absolute Maximum Ratings table for clarification .....                                                                                                                                                                                                                                 | <b>5</b>    |
| • Changed Handling Ratings to ESD Ratings and replaced MIN/MAX values with ± VALUE for clarification .....                                                                                                                                                                                                              | <b>6</b>    |
| • Added TPS826716 data and removed Product Preview note. ....                                                                                                                                                                                                                                                           | <b>7</b>    |
| <b>Changes from Revision G (September 2014) to Revision H</b>                                                                                                                                                                                                                                                           | <b>Page</b> |
| • Added TPS826716 to Device Comparison Table as Product Preview. ....                                                                                                                                                                                                                                                   | <b>4</b>    |
| <b>Changes from Revision F (November 2012) to Revision G</b>                                                                                                                                                                                                                                                            | <b>Page</b> |
| • Added Device Information and Handling Rating tables, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. .... | <b>1</b>    |
| • Added device TPS826721 .....                                                                                                                                                                                                                                                                                          | <b>4</b>    |
| <b>Changes from Revision E (October 2012) to Revision F</b>                                                                                                                                                                                                                                                             | <b>Page</b> |
| • Added TPS826745 to Header .....                                                                                                                                                                                                                                                                                       | <b>1</b>    |

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**Changes from Revision D (April 2012) to Revision E** **Page**


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- Added TPS826765 to Header ..... [1](#)
- 

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**Changes from Revision C (November 2011) to Revision D** **Page**


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- Added devices TPS82670, TPS82673, and TPS82674 to Header ..... [1](#)
- 

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**Changes from Revision B (August 2011) to Revision C** **Page**


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- Added device TPS82672 to Header info ..... [1](#)
- 

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**Changes from Revision A (April 2011) to Revision B** **Page**


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- Added TPS82676 part number to data sheet header ..... [1](#)
- 

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**Changes from Original (October 2010) to Revision A** **Page**


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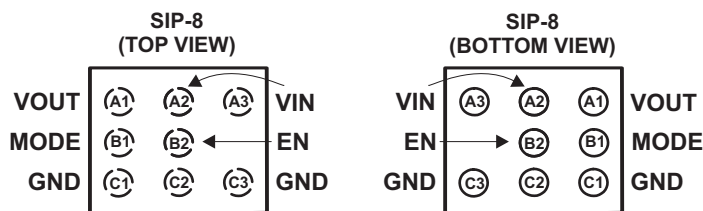
- Added devices TPS82677 and TPS82678 to Header info ..... [1](#)
  - Added copyright attribution for spectrum illustrations ..... [11](#)
-

## 6 Device Comparison Table

| PART NUMBER <sup>(1)</sup> | OUTPUT VOLTAGE | DEVICE SPECIFIC FEATURE                                                                       | PACKAGE MARKING |
|----------------------------|----------------|-----------------------------------------------------------------------------------------------|-----------------|
| TPS82670                   | 1.86V          | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | YK              |
| TPS82671                   | 1.8V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | RA              |
| TPS826711                  | 1.8V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | YW              |
| TPS826716                  | 1.6V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | GS              |
| TPS82672                   | 1.5V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | WD              |
| TPS826721                  | 2.1V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | EO              |
| TPS82673                   | 1.26V          | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | YL              |
| TPS82674                   | 1.2V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | SW              |
| TPS826745                  | 1.225V         | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | B5              |
| TPS82675                   | 1.2V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | RB              |
| TPS82676                   | 1.1V           | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | TU              |
| TPS826765                  | 1.05V          | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage<br>Output Capacitor Discharge | AN              |
| TPS82677                   | 1.2V           | Output Capacitor Discharge                                                                    | SK              |
| TPS8267195                 | 1.95V          | PWM Spread Spectrum Modulation<br>Low PFM Output Ripple Voltage                               | 4A              |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com)

## 7 Pin Configuration and Functions



### Pin Functions

| PIN  |            | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                    |
|------|------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | NO.        |     |                                                                                                                                                                                                                                                                                                                                                                                                |
| VOUT | A1         | O   | Power output pin. Apply output load between this pin and GND.                                                                                                                                                                                                                                                                                                                                  |
| VIN  | A2, A3     | I   | The VIN pins supply current to the TPS8267x internal regulator.                                                                                                                                                                                                                                                                                                                                |
| EN   | B2         | I   | This is the enable pin of the device. Connect this pin to ground to force the converter into shutdown mode. Pull this pin to $V_I$ to enable the device. This pin must not be left floating and must be terminated.                                                                                                                                                                            |
| MODE | B1         | I   | This is the mode selection pin of the device. This pin must not be left floating and must be terminated.<br>MODE = LOW: The device is operating in regulated frequency pulse width modulation mode (PWM) at high-load currents and in pulse frequency modulation mode (PFM) at light load currents.<br>MODE = HIGH: Low-noise mode is enabled and regulated frequency PWM operation is forced. |
| GND  | C1, C2, C3 | –   | Ground pin.                                                                                                                                                                                                                                                                                                                                                                                    |

## 8 Specifications

### 8.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                      |                                            | MIN                | MAX            | UNIT |
|----------------------|--------------------------------------------|--------------------|----------------|------|
| $V_I$ <sup>(2)</sup> | Voltage at VIN <sup>(3)</sup>              | –0.3               | 6              | V    |
|                      | Voltage at VIN (TPS826721) <sup>(3)</sup>  | –0.3               | 5.5            | V    |
|                      | Voltage at VOUT                            | –0.3               | 3.6            | V    |
|                      | Voltage at EN, MODE                        | –0.3               | $V_{IN} + 0.3$ | V    |
|                      | Power dissipation                          | Internally limited |                |      |
| $T_A$                | Operating temperature range <sup>(4)</sup> | –40                | 85             | °C   |
| $T_{INT(max)}$       | Maximum internal operating temperature     |                    | 125            | °C   |
| $T_{stg}$            | Storage temperature                        | –55                | 125            | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground terminal.
- (3) Operation above 4.8V input voltage for extended periods may affect device reliability.
- (4) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ( $T_{A(max)}$ ) is dependent on the maximum operating temperature ( $T_{INT(max)}$ ), the maximum power dissipation of the device in the application ( $P_{D(max)}$ ), and the junction-to-ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by the following equation:  $T_{A(max)} = T_{J(max)} - (R_{\theta JA} \times P_{D(max)})$ . To achieve optimum performance, it is recommended to operate the device with a maximum internal temperature of 105°C.

## 8.2 ESD Ratings

|                 |                                                             | VALUE | UNIT |
|-----------------|-------------------------------------------------------------|-------|------|
| $V_{ESD}^{(1)}$ | Human body model (HBM) ESD stress voltage <sup>(2)</sup>    | ±2000 | V    |
|                 | Charge device model (CDM) ESD stress voltage <sup>(3)</sup> | ±1000 |      |
|                 | Machine model (MM) ESD stress voltage <sup>(4)</sup>        | ±200  | V    |

- (1) Electrostatic discharge (ESD) to measure device sensitivity and immunity to damage caused by assembly line electrostatic discharges in to the device.
- (2) Level listed above is the passing level per ANSI, ESDA, and JEDEC JS-001. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (3) Level listed above is the passing level per EIA-JEDEC JESD22-C101. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.
- (4) The machine model is a 200-pF capacitor discharged directly into each pin.

## 8.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|          |                                                                  |                                                                                      | MIN | NOM | MAX                | UNIT |
|----------|------------------------------------------------------------------|--------------------------------------------------------------------------------------|-----|-----|--------------------|------|
| $V_{IN}$ | Input voltage range                                              |                                                                                      | 2.3 |     | 4.8 <sup>(1)</sup> | V    |
| $I_O$    | Output current range                                             | TPS82671 to TPS826765                                                                | 0   |     | 600                | mA   |
|          | Additional output capacitance (PFM/PWM operation) <sup>(2)</sup> | TPS82670 to TPS82676<br>TPS826711, TPS826716,<br>TPS826721, TPS826765,<br>TPS8267195 |     | 0   | 2.5                | μF   |
|          |                                                                  | TPS82677                                                                             |     | 0   | 4                  | μF   |
|          | Additional output capacitance (PWM operation) <sup>(2)</sup>     |                                                                                      |     | 0   | 7                  | μF   |
| $T_A$    | Ambient temperature                                              |                                                                                      | −40 |     | +85                | °C   |
| $T_J$    | Operating junction temperature                                   |                                                                                      | −40 |     | +125               | °C   |

- (1) Operation above 4.8V input voltage for extended periods may affect device reliability.
- (2) In certain applications larger capacitor values can be tolerable, see [Output Capacitor Selection](#) section for more details.

## 8.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                                 | TPS8267x | UNIT |
|-------------------------------|-------------------------------------------------|----------|------|
|                               |                                                 | SIP      |      |
|                               |                                                 | 8 PINS   |      |
| $R_{\theta JA}$               | Junction-to-ambient (top) thermal resistance    | 125      | °C/W |
|                               | Junction-to-ambient (bottom) thermal resistance | 70       |      |
| $R_{\theta JCTop}$            | Junction-to-case (top) thermal resistance       | -        |      |
| $R_{\theta JB}$               | Junction-to-board thermal resistance            | -        |      |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter      | -        |      |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter    | -        |      |
| $R_{\theta JCbott}$           | Junction-to-case (bottom) thermal resistance    | -        |      |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 8.5 Electrical Characteristics

Minimum and maximum values are at  $V_{IN} = 2.3V$  to  $5.5V$ ,  $V_{OUT} = 1.8V$ ,  $EN = 1.8V$ , AUTO mode and  $T_A = -40^{\circ}C$  to  $85^{\circ}C$ ; Circuit of Parameter Measurement Information section (unless otherwise noted). Typical values are at  $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.8V$ ,  $EN = 1.8V$ , AUTO mode and  $T_A = 25^{\circ}C$  (unless otherwise noted).

| PARAMETER             | TEST CONDITIONS                | MIN                                | TYP  | MAX  | UNIT |
|-----------------------|--------------------------------|------------------------------------|------|------|------|
| <b>SUPPLY CURRENT</b> |                                |                                    |      |      |      |
| $I_Q$                 | Operating quiescent current    | $I_O = 0mA$ . Device not switching | 17   | 40   | μA   |
|                       |                                | $I_O = 0mA$ . PWM operation        | 5.8  |      | mA   |
| $I_{SD}$              | Shutdown current               | $EN = GND$                         | 0.5  | 5    | μA   |
| UVLO                  | Undervoltage lockout threshold | TPS8267195 only                    | 2.08 | 2.14 | V    |
|                       |                                | all other versions                 | 2.05 | 2.1  |      |

## Electrical Characteristics (continued)

Minimum and maximum values are at  $V_{IN} = 2.3V$  to  $5.5V$ ,  $V_{OUT} = 1.8V$ ,  $EN = 1.8V$ , AUTO mode and  $T_A = -40^{\circ}C$  to  $85^{\circ}C$ ; Circuit of Parameter Measurement Information section (unless otherwise noted). Typical values are at  $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.8V$ ,  $EN = 1.8V$ , AUTO mode and  $T_A = 25^{\circ}C$  (unless otherwise noted).

| PARAMETER        |                                                    |                                                                        | TEST CONDITIONS                                                                    | MIN                    | TYP              | MAX                    | UNIT             |
|------------------|----------------------------------------------------|------------------------------------------------------------------------|------------------------------------------------------------------------------------|------------------------|------------------|------------------------|------------------|
| PROTECTION       |                                                    |                                                                        |                                                                                    |                        |                  |                        |                  |
|                  | Thermal shutdown                                   |                                                                        |                                                                                    |                        | 140              |                        | °C               |
|                  | Thermal shutdown hysteresis                        |                                                                        |                                                                                    |                        | 10               |                        | °C               |
| I <sub>LIM</sub> | Peak Input Current Limit                           |                                                                        |                                                                                    |                        | 1100             |                        | mA               |
| I <sub>SC</sub>  | Input current limit under short-circuit conditions |                                                                        | V <sub>O</sub> shorted to ground                                                   |                        | 13.5             |                        | mA               |
| ENABLE, MODE     |                                                    |                                                                        |                                                                                    |                        |                  |                        |                  |
| V <sub>IH</sub>  | High-level input voltage                           |                                                                        |                                                                                    | 1.0                    |                  |                        | V                |
| V <sub>IL</sub>  | Low-level input voltage                            |                                                                        |                                                                                    |                        |                  | 0.4                    | V                |
| I <sub>lkg</sub> | Input leakage current                              |                                                                        | Input connected to GND or VIN                                                      |                        | 0.01             | 1.5                    | μA               |
| OSCILLATOR       |                                                    |                                                                        |                                                                                    |                        |                  |                        |                  |
| f <sub>SW</sub>  | Oscillator frequency                               |                                                                        | I <sub>O</sub> = 0mA. PWM operation                                                | 4.9                    | 5.45             | 6.0                    | MHz              |
| OUTPUT           |                                                    |                                                                        |                                                                                    |                        |                  |                        |                  |
| V <sub>OUT</sub> | Regulated DC output voltage                        | TPS82670<br>TPS82671<br>TPS826711                                      | 2.5V ≤ V <sub>I</sub> ≤ 4.8V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PFM/PWM operation   | 0.98×V <sub>NOM</sub>  | V <sub>NOM</sub> | 1.03×V <sub>NOM</sub>  | V                |
|                  |                                                    | TPS826716<br>TPS82672<br>TPS826721                                     | 2.5V ≤ V <sub>I</sub> ≤ 5.5V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PFM/PWM operation   | 0.98×V <sub>NOM</sub>  | V <sub>NOM</sub> | 1.04×V <sub>NOM</sub>  | V                |
|                  |                                                    | TPS82673<br>TPS82674<br>TPS826745<br>TPS82675<br>TPS82676<br>TPS826765 | 2.5V ≤ V <sub>I</sub> ≤ 5.5V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PWM operation       | 0.98×V <sub>NOM</sub>  | V <sub>NOM</sub> | 1.02×V <sub>NOM</sub>  | V                |
|                  |                                                    | TPS8267195                                                             | 2.5V ≤ V <sub>I</sub> ≤ 4.8V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PFM/PWM operation   | 0.975×V <sub>NOM</sub> | V <sub>NOM</sub> | 1.035×V <sub>NOM</sub> | V                |
|                  |                                                    |                                                                        | 2.5V ≤ V <sub>I</sub> ≤ 5.5V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PFM/PWM operation   | 0.975×V <sub>NOM</sub> | V <sub>NOM</sub> | 1.045×V <sub>NOM</sub> | V                |
|                  |                                                    |                                                                        | 2.5V ≤ V <sub>I</sub> ≤ 5.5V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PWM operation       | 0.975×V <sub>NOM</sub> | V <sub>NOM</sub> | 1.025×V <sub>NOM</sub> | V                |
|                  |                                                    | TPS82677                                                               | 2.5V ≤ V <sub>I</sub> ≤ 4.8V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PFM/PWM operation   | 0.98×V <sub>NOM</sub>  | V <sub>NOM</sub> | 1.04×V <sub>NOM</sub>  | V                |
|                  |                                                    |                                                                        | 2.5V ≤ V <sub>I</sub> ≤ 5.5V, 0mA ≤ I <sub>O</sub> ≤ 600 mA<br>PWM operation       | 0.98×V <sub>NOM</sub>  | V <sub>NOM</sub> | 1.02×V <sub>NOM</sub>  | V                |
|                  | Line regulation                                    |                                                                        | V <sub>I</sub> = V <sub>O</sub> + 0.5V (min 2.5V) to 5.5V, I <sub>O</sub> = 200 mA |                        | 0.23             |                        | %/V              |
|                  | Load regulation                                    |                                                                        | I <sub>O</sub> = 0mA to 600 mA. PWM operation                                      |                        | −0.00085         |                        | %/mA             |
|                  | Feedback input resistance                          |                                                                        |                                                                                    |                        | 480              |                        | kΩ               |
| ΔV <sub>O</sub>  | Power-save mode ripple voltage                     | TPS82671<br>TPS826711                                                  | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.8V                                        |                        | 19               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS826716                                                              | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.6V                                        |                        | 19               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS826721                                                              | I <sub>O</sub> = 1mA, V <sub>O</sub> = 2.1V                                        |                        | 19               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS82673<br>TPS82674<br>TPS826745<br>TPS82675                          | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.2V                                        |                        | 16               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS82676                                                               | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.1V                                        |                        | 16               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS826765                                                              | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.05V                                       |                        | 16               |                        | mV <sub>PP</sub> |
|                  |                                                    | TPS82677                                                               | I <sub>O</sub> = 1mA, V <sub>O</sub> = 1.2V                                        |                        | 25               |                        | mV <sub>PP</sub> |
|                  | Start-up time                                      | TPS82671<br>TPS826711                                                  | I <sub>O</sub> = 0mA, Time from active EN to V <sub>O</sub>                        |                        | 120              |                        | μs               |
| r <sub>DIS</sub> | Discharge resistor for power-down sequence         |                                                                        | Devices featuring active discharge                                                 |                        | 70               | 150                    | Ω                |

## 8.6 Typical Characteristics

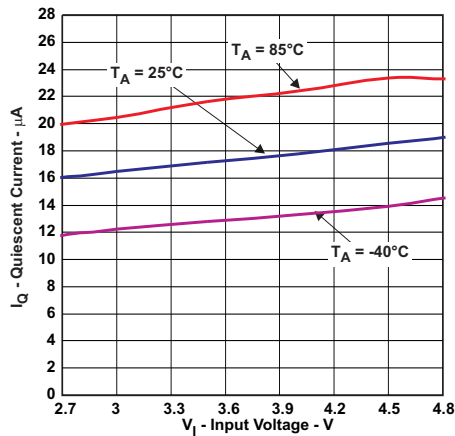


Figure 1. Quiescent Current vs. Input Voltage

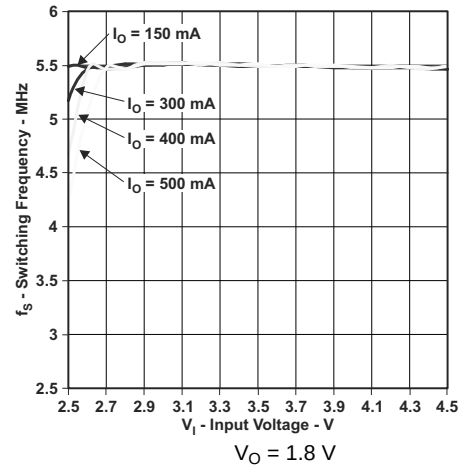


Figure 2. PWM Switching Frequency vs. Input Voltage

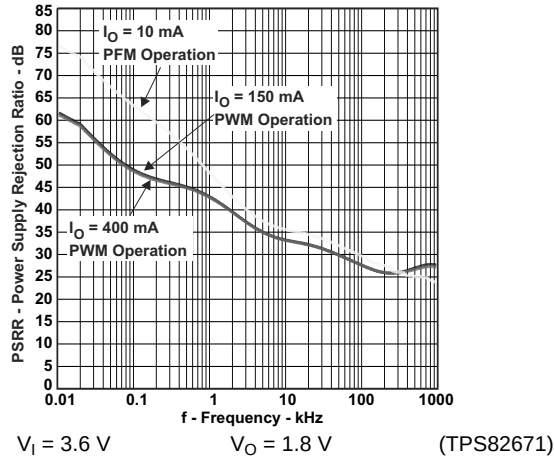


Figure 3. Power Supply Rejection Ratio vs. Frequency

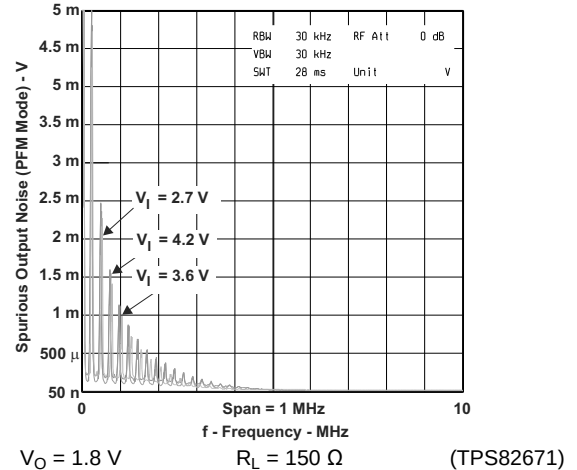


Figure 4. Spurious Output Noise (PFM Mode) vs. Frequency

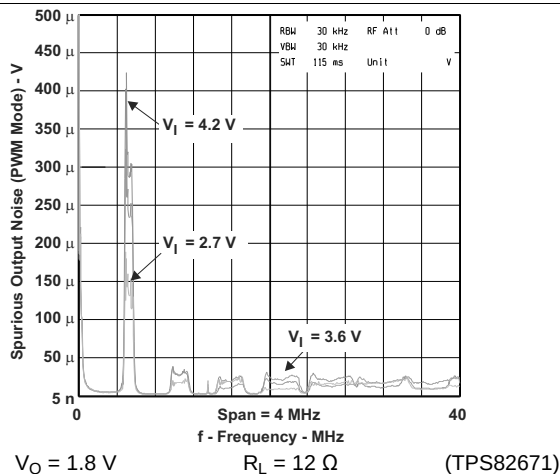


Figure 5. Spurious Output Noise (PWM Mode) vs. Frequency

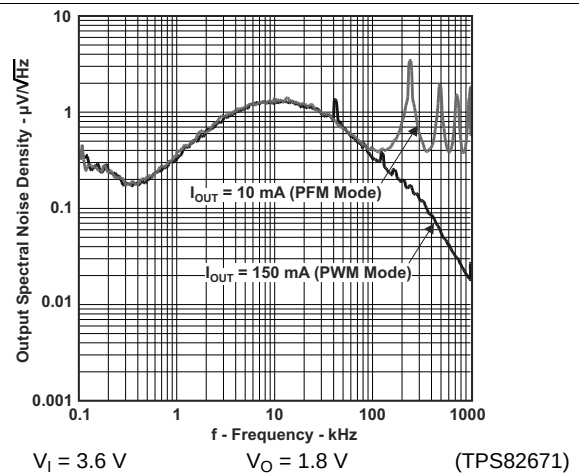


Figure 6. Output Spectral Noise Density vs. Frequency



## 9 Detailed Description

### 9.1 Overview

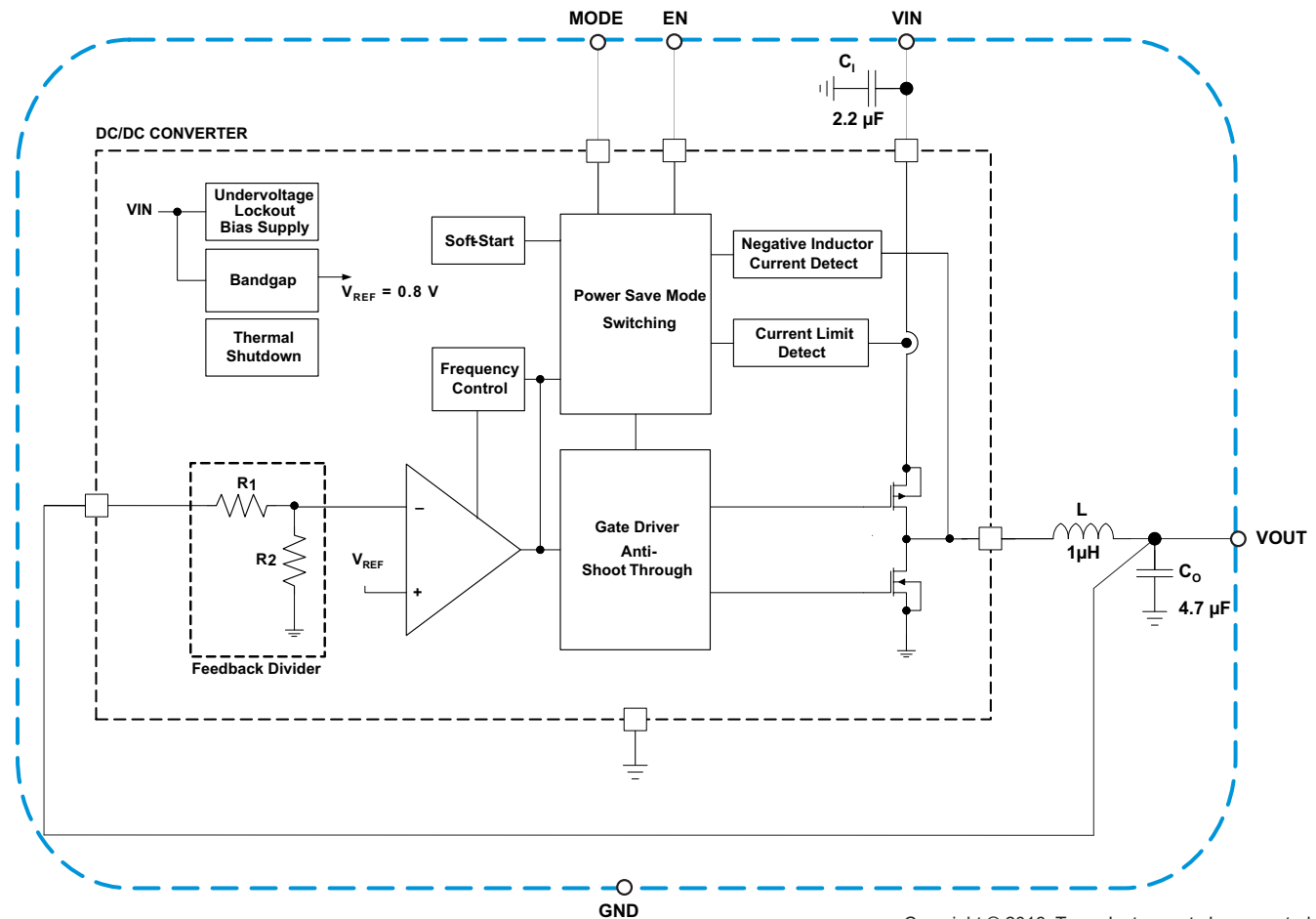
The TPS8267x is a stand-alone, synchronous, step-down converter. The converter operates at a regulated 5.5-MHz frequency pulse width modulation (PWM) at moderate to heavy load currents. At light load currents, the TPS8267x converter operates in power-save mode with pulse frequency modulation (PFM).

The converter uses a unique frequency-locked ring-oscillating modulator to achieve *best-in-class* load and line response. One key advantage of the non-linear architecture is that there is no traditional feed-back loop. The loop response to change in  $V_O$  is essentially instantaneous, which explains the transient response. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency lock loop (FLL) holds the switching frequency constant over a large range of operating conditions.

Combined with *best-in-class* load and line-transient response characteristics, the low quiescent current of the device (approximately 17 $\mu$ A) helps to maintain high efficiency at light load while that current preserves a fast transient response for applications that require tight output regulation.

The TPS8267x integrates an input current limit to protect the device against heavy load or short circuits and features an undervoltage lockout circuit to prevent the device from misoperation at low input voltages. Fully functional operation is permitted down to 2.1V input voltage.

### 9.2 Functional Block Diagram



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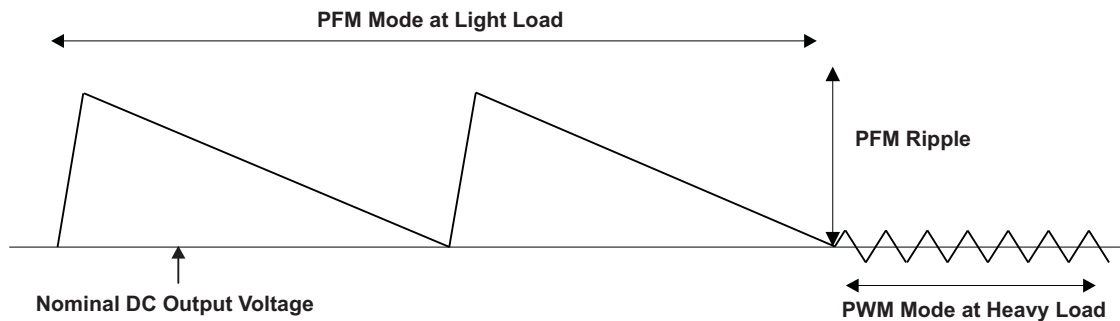
## 9.3 Feature Description

### 9.3.1 Power-Save Mode

If the load current decreases, the converter enters power-save mode automatically. During power-save mode, the converter operates in discontinuous current, (DCM) single-pulse PFM mode, which produces a low output ripple compared with other PFM architectures.

When in power-save mode, the converter resumes its operation when the output voltage falls below the nominal voltage. The converter ramps up the output voltage with a minimum of one pulse and goes into power-save mode when the output voltage is within its regulation limits.

The IC exits PFM mode and enters PWM mode when the output current can no longer be supported in PFM mode. As a consequence, the DC output voltage is typically positioned approximately 0.5% above the nominal output voltage. The transition between PFM and PWM is seamless.



**Figure 7. Operation In PFM Mode And Transfer To PWM Mode**

### 9.3.2 Mode Selection

The MODE pin selects the operating mode of the device. Connecting the MODE pin to GND enables the automatic PWM and power-save mode operation. The converter operates in regulated frequency PWM mode at moderate to heavy loads, and operates in PFM mode during light loads. This type of operation maintains high efficiency over a wide load current range.

Pulling the MODE pin high forces the converter to operate in PWM mode even at light-load currents. The advantage is that the converter modulates its switching frequency according to a spread spectrum PWM modulation technique that allows simple filtering of the switching harmonics in noise-sensitive applications. In this mode, the efficiency is lower when compared to the power-save mode during light loads.

For additional flexibility, it is possible to switch from power-save mode to PWM mode during operation. This type of operation allows efficient power management by adjusting the operation of the converter to the specific system requirements.

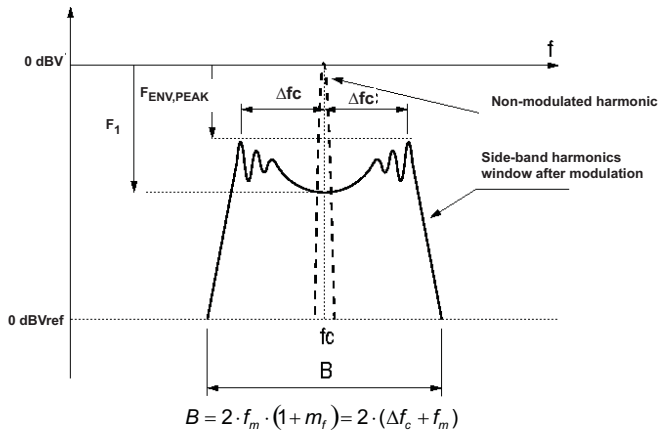
### 9.3.3 Spread Spectrum, PWM Frequency Dithering

The goal of spread spectrum architecture is to spread out the emitted RF energy over a larger frequency range so that any resulting electromagnetic interference (EMI) is similar to white noise. The end result is a spectrum that is continuous and lower in peak amplitude. Spread spectrum makes it easier to comply with EMI standards. It also makes it easier to comply with the power supply ripple requirements in cellular and non-cellular wireless applications. Radio receivers are typically susceptible to narrowband noise that is focused on specific frequencies.

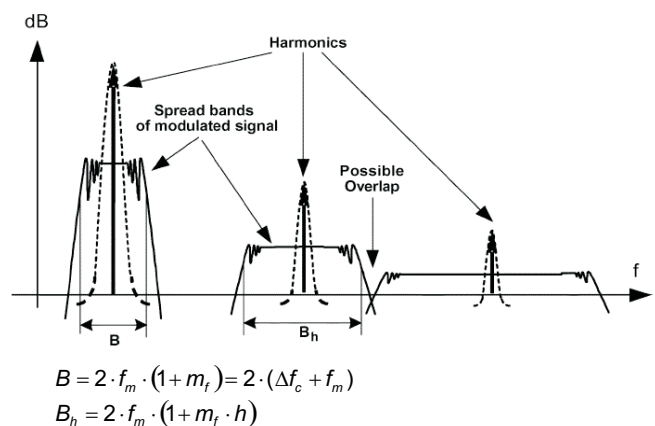
Switching regulators can be particularly troublesome in applications where electromagnetic interference (EMI) is a concern. Switching regulators operate on a cycle-by-cycle basis to transfer power to an output. In most cases, the frequency of operation is either fixed or regulated, based on the output load. This method of conversion creates large components of noise at the frequency of operation (fundamental) and multiples of the operating frequency (harmonics).

## Feature Description (continued)

The spread spectrum architecture varies the switching frequency by approximately  $\pm 10\%$  of the nominal switching frequency, thereby significantly reduces the peak radiated and conducting noise on both the input and output supplies. The frequency dithering scheme is modulated with a triangle profile and a modulation frequency  $f_m$ .



**Figure 8. Spectrum Of A Frequency Modulated Sin. Wave With Sinusoidal Variation In Time**



**Figure 9. Spread Bands Of Harmonics In Modulated Square Signals <sup>(1)</sup>**

Figure 8 and Figure 9 show that after modulation the sideband harmonic is attenuated when compared to the non-modulated harmonic, and when the harmonic energy is spread into a certain frequency band. The higher the modulation index ( $m_f$ ) the larger the attenuation.

$$m_f = \frac{\delta \times f_c}{f_m}$$

(1)

With:

$f_c$  is the carrier frequency (i.e. nominal switching frequency)

$f_m$  is the modulating frequency (approx.  $0.016 \times f_c$ )

$\delta$  is the modulation ratio (approx 0.1)

$$\delta = \frac{\Delta f_c}{f_c}$$

(2)

The maximum switching frequency is limited by the process and by the parameter modulation ratio ( $\delta$ ), together with  $f_m$ , which is the bandwidth of the side-band harmonics around the carrier frequency  $f_c$ . The bandwidth of a frequency modulated waveform is approximately given by the Carson's rule and can be summarized as:

$$B = 2 \times f_m \times (1 + m_f) = 2 \times (\Delta f_c + f_m)$$

(3)

$f_m < \text{RBW}$ : The receiver is not able to distinguish individual side-band harmonics; so, several harmonics are added in the input filter and the measured value is higher than expected in theoretical calculations.

$f_m > \text{RBW}$ : The receiver is able to properly measure each individual side-band harmonic separately, so that the measurements match the theoretical calculations.

(1) Spectrum illustrations and formulae (Figure 8 and Figure 9) copyright IEEE TRANSACTIONS ON ELECTROMAGNETIC COMPATIBILITY, VOL. 47, NO.3, AUGUST 2005. See References Section for full citation.

## 9.4 Device Functional Modes

### 9.4.1 Enable

The TPS8267x device starts operation when EN is set high and starts up with the soft start as previously described. For proper operation, the EN pin must be terminated and must not be left floating.

Pulling the EN pin low forces the device into shutdown. In this mode, all internal circuits are turned off and the  $V_{IN}$  current reduces to the device leakage current, which is typically a few hundred nanoamps.

The TPS8267x device can actively discharge the output capacitor when it turns off. The integrated discharge resistor has a typical resistance of 100  $\Omega$ . The required time to ramp down the output voltage depends on the load current and the capacitance present at the output node.

### 9.4.2 Soft Start

The TPS8267x has an internal soft-start circuit that limits the in-rush current during start-up. This circuit limits input voltage drop when a battery or a high-impedance power source is connected to the input of the MicroSiP™ DC/DC converter.

The soft-start system progressively increases the switching on-time from a minimum pulse-width of 35ns as a function of the output voltage. This mode of operation continues for approximately 100 $\mu$ s after the enable. If the output voltage does not reach its target value within the soft-start time, the soft-start transitions to a second mode of operation.

If the output voltage rises above approximately 0.5V, the converter increases the input current limit and thus enables the power supply to come up properly. The start-up time mainly depends on the capacitance present at the output node and the load current.

## 10 Applications and Implementation

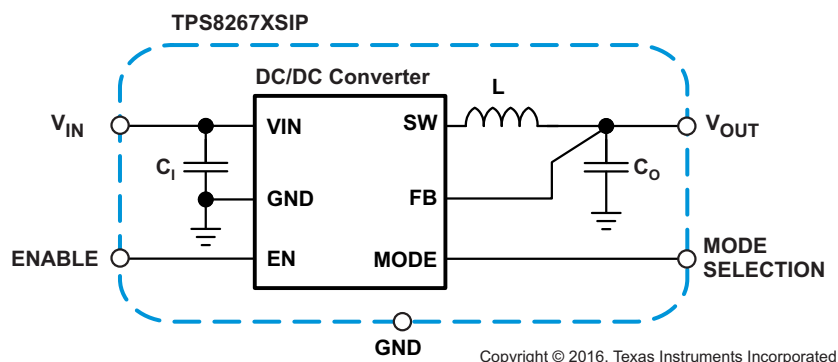
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

The TPS8267x devices are complete power supply modules, not needing further external devices. The devices are optimized to work best with the components populated. However application conditions might demand for different input and/or output capacitance values.

### 10.2 Typical Application



**Figure 10. MicroSIP Converter Module Schematic**

#### 10.2.1 Design Requirements

For applications requiring additional input and/or output capacitance, the following procedures should be considered. For the maximum recommended values see [Recommended Operating Conditions](#).

#### 10.2.2 Detailed Design Procedure

##### 10.2.2.1 Input Capacitor Selection

Because of the pulsating input current nature of the buck converter, a low ESR input capacitor is required to prevent large voltage transients that can cause misbehavior of the device or interference in other circuits in the system.

For most applications, the input capacitor that is integrated into the TPS8267x should be sufficient. If the application exhibits a noisy or erratic switching frequency, experiment with additional input ceramic capacitance to find a remedy.

The TPS8267x uses a tiny ceramic input capacitor. When a ceramic capacitor is combined with trace or cable inductance, such as from a wall adapter, a load step at the output can induce ringing at the VIN pin. This ringing can couple to the output and be mistaken as loop instability or can even damage the part. In this circumstance, additional "bulk" capacitance, such as electrolytic or tantalum, should be placed between the input of the converter and the power source lead to reduce ringing that can occur between the inductance of the power source leads and  $C_1$ .

##### 10.2.2.2 Output Capacitor Selection

The advanced, fast-response, voltage mode, control scheme of the TPS8267x allows the use of a tiny ceramic output capacitor ( $C_O$ ). For most applications, the output capacitor integrated in the TPS8267x is sufficient.

## Typical Application (continued)

At nominal load current, the device operates in PWM mode; the overall output voltage ripple is the sum of the voltage step that is caused by the output capacitor ESL and the ripple current that flows through the output capacitor impedance. At light loads, the output capacitor limits the output ripple voltage and provides holdup during large load transitions.

The TPS8267x is designed as a Point-Of-Load (POL) regulator, to operate stand-alone without requiring any additional capacitance. Adding a 2.2μF ceramic output capacitor (X7R or X5R dielectric) generally works from a converter stability point of view, but does not necessarily help to minimize the output ripple voltage.

For best operation (i.e. optimum efficiency over the entire load current range, proper PFM/PWM auto transition), the TPS8267xSiP requires a minimum output ripple voltage in PFM mode. The typical output voltage ripple is ca. 1% of the nominal output voltage  $V_O$ . The PFM pulses are time controlled resulting in a PFM output voltage ripple and PFM frequency that depends (first order) on the capacitance seen at the MicroSiP™ DC/DC converter's output.

In applications requiring additional output bypass capacitors located close to the load, care should be taken to ensure proper operation. If the converter exhibits marginal stability or erratic switching frequency, experiment with additional low value series resistance (e.g. 50 to 100mΩ) in the output path to find a remedy.

Because the damping factor in the output path is directly related to several resistive parameters (e.g. inductor DCR, power-stage  $r_{DS(on)}$ , PWB DC resistance, load switches  $r_{DS(on)}$  ...) that are temperature dependant, the converter small and large signal behavior must be checked over the input voltage range, load current range and temperature range.

The easiest sanity test is to evaluate, directly at the converter's output, the following aspects:

- PFM/PWM efficiency
- PFM/PWM and forced PWM load transient response

During the recovery time from a load transient, the output voltage can be monitored for settling time, overshoot or ringing that helps judge the converter's stability. Without any ringing, the loop has usually more than 45° of phase margin.

## Typical Application (continued)

### 10.2.3 Application Curves

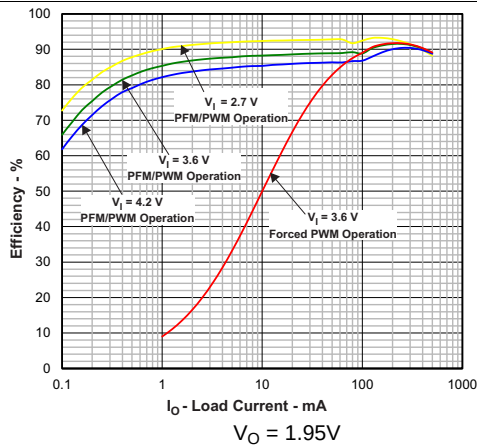


Figure 11. Efficiency vs. Load Current

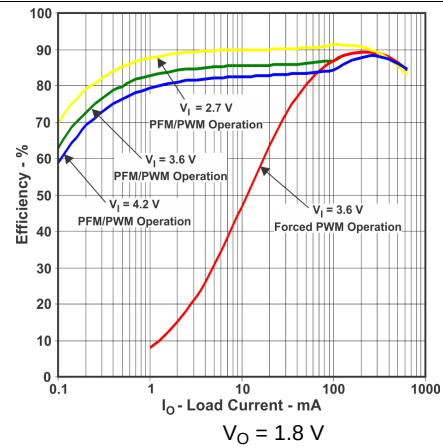


Figure 12. Efficiency vs. Load Current

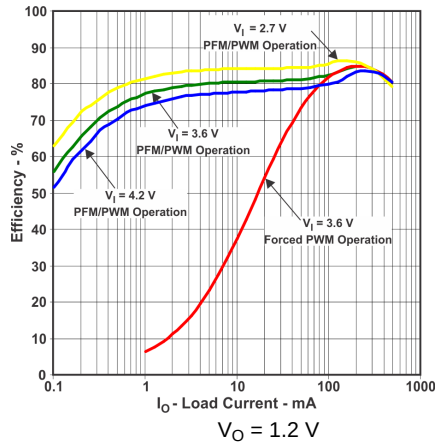


Figure 13. Efficiency vs. Load Current

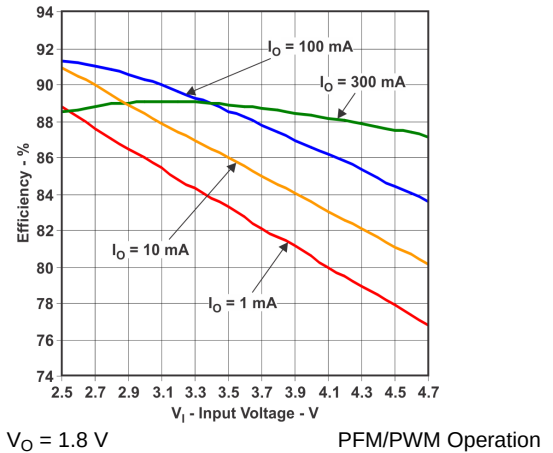


Figure 14. Efficiency vs. Input Voltage

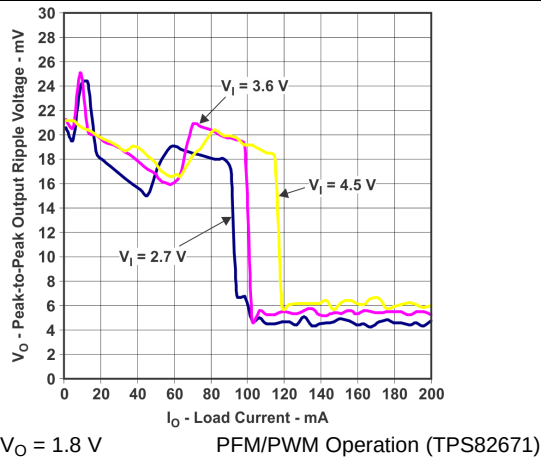


Figure 15. Peak-to-Peak Output Ripple Voltage vs. Load Current

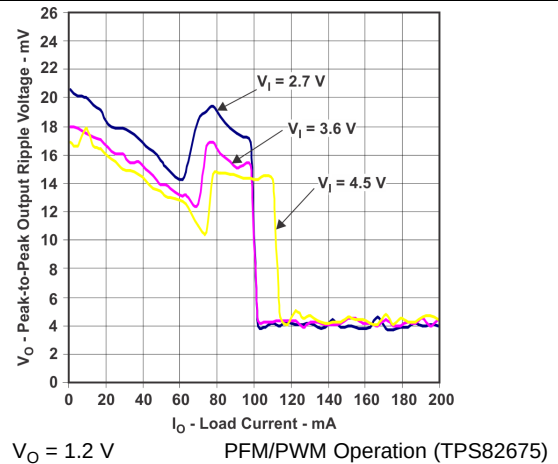
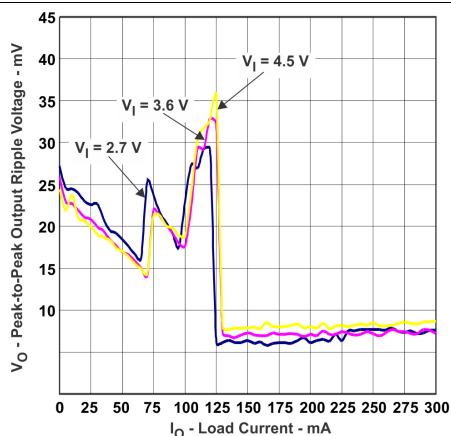


Figure 16. Peak-to-Peak Output Ripple Voltage vs. Load Current

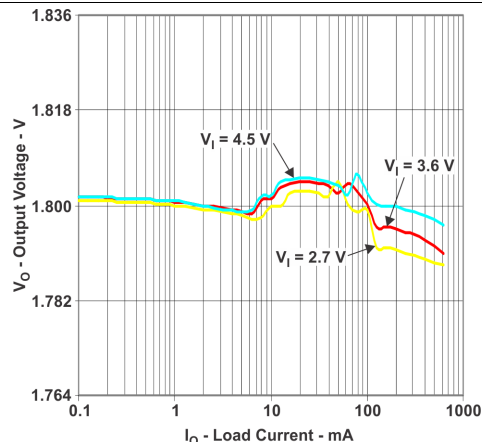


## Typical Application (continued)



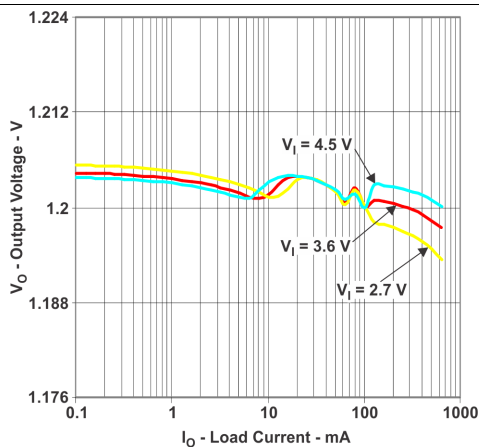
$V_O = 1.2 \text{ V}$  (TPS82671)

Figure 17. Peak-to-Peak Output Ripple Voltage vs. Load Current



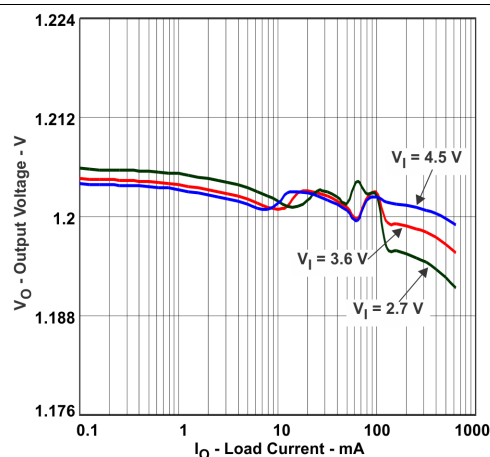
$V_O = 1.8 \text{ V}$  PFM/PWM Operation (TPS82671)

Figure 18. DC Output Voltage vs. Load Current



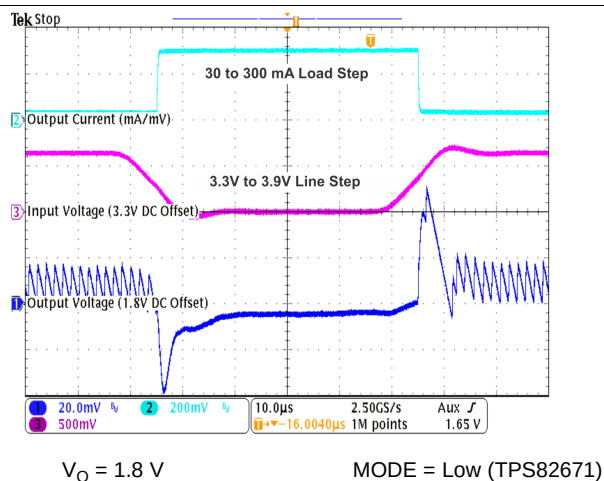
$V_O = 1.2 \text{ V}$  (TPS82675)

Figure 19. DC Output Voltage vs. Load Current



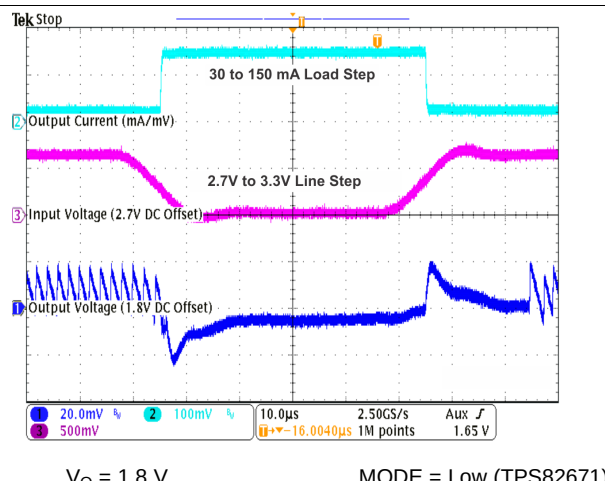
$V_O = 1.2 \text{ V}$  PFM/PWM Operation (TPS82677)

Figure 20. DC Output Voltage vs. Load Current



$V_O = 1.8 \text{ V}$  MODE = Low (TPS82671)

Figure 21. Combined Line/Load Transient Response

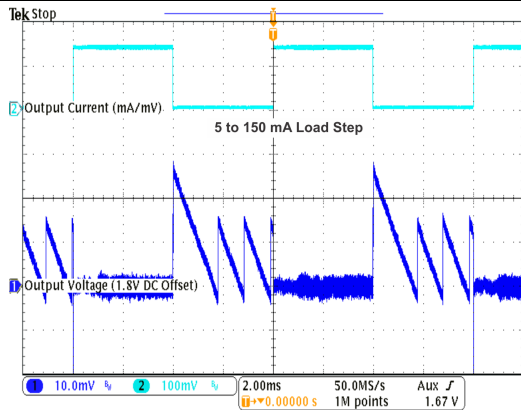


$V_O = 1.8 \text{ V}$  MODE = Low (TPS82671)

Figure 22. Combined Line/Load Transient Response

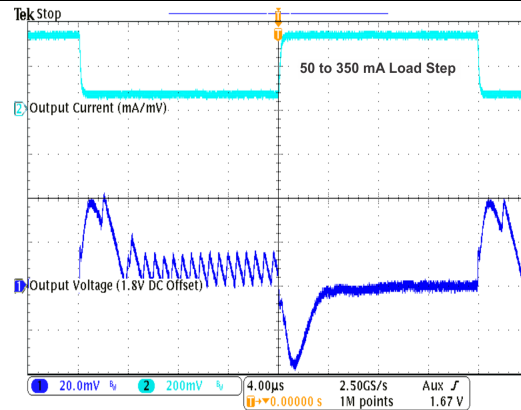


## Typical Application (continued)



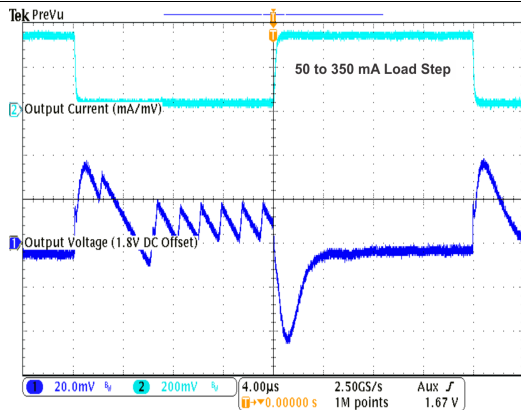
$V_O = 1.8\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low (TPS82671)

Figure 23. Load Transient Response in PFM/PWM Operation



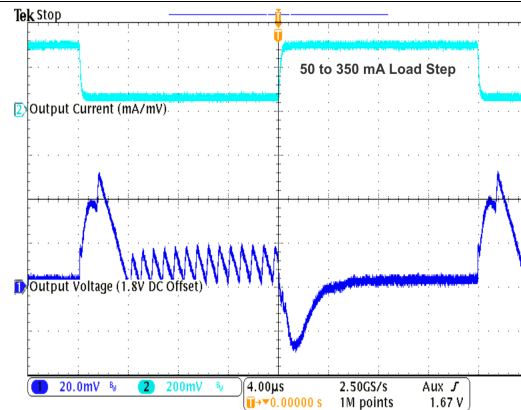
$V_O = 1.8\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low (TPS82671)

Figure 24. Load Transient Response in PFM/PWM Operation



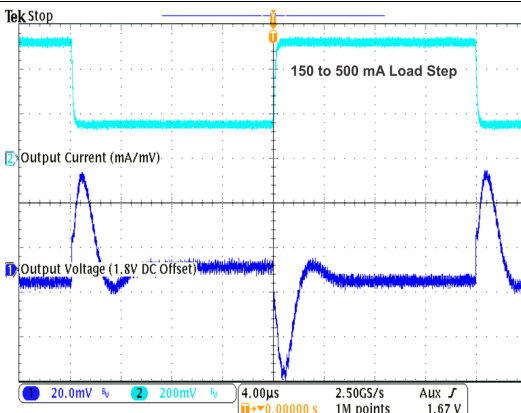
$V_O = 1.8\text{ V}$   $V_I = 2.7\text{ V}$  MODE = Low (TPS82671)

Figure 25. Load Transient Response in PFM/PWM Operation



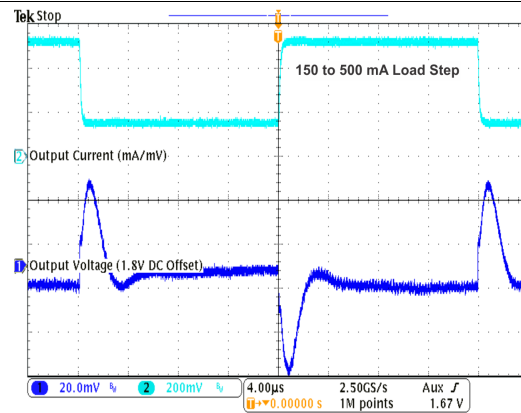
$V_O = 1.8\text{ V}$   $V_I = 4.5\text{ V}$  MODE = Low (TPS82671)

Figure 26. Load Transient Response in PFM/PWM Operation



$V_O = 1.8\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low (TPS82671)

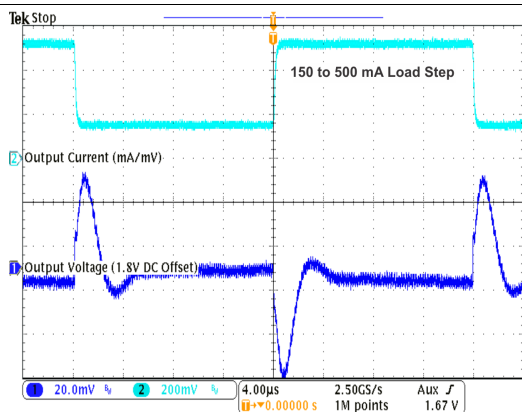
Figure 27. Load Transient Response in PFM/PWM Operation



$V_O = 1.8\text{ V}$   $V_I = 2.7\text{ V}$  MODE = Low (TPS82671)

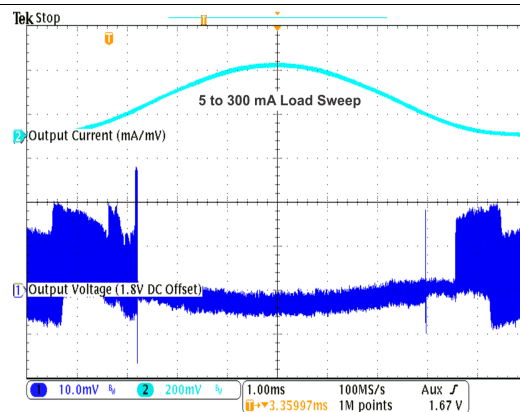
Figure 28. Load Transient Response in PFM/PWM Operation

## Typical Application (continued)



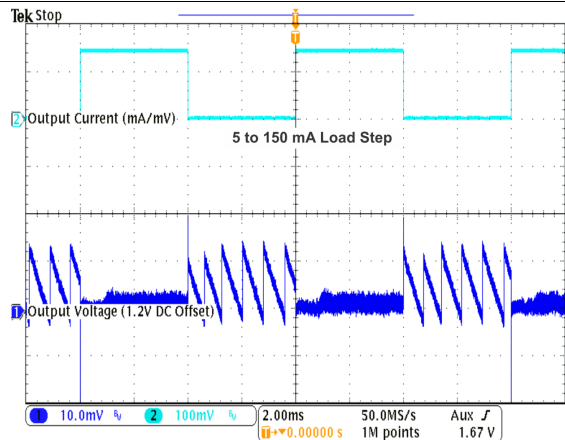
$V_O = 1.8\text{ V}$   $V_I = 4.5\text{ V}$  MODE = Low (TPS82671)

**Figure 29. Load Transient Response in PFM/PWM Operation**



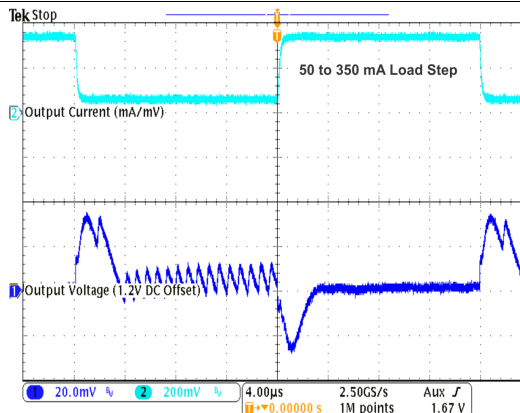
$V_O = 1.8\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low (TPS82671)

**Figure 30. AC Load Transient Response**



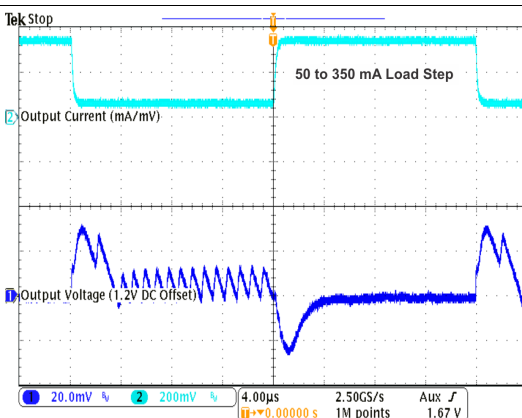
$V_O = 1.2\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low

**Figure 31. Load Transient Response in PFM/PWM Operation**



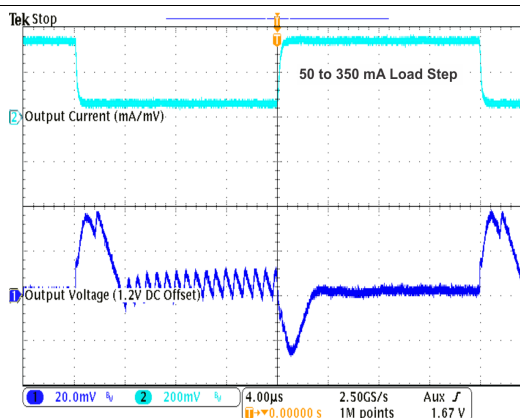
$V_O = 1.2\text{ V}$   $V_I = 3.6\text{ V}$  MODE = Low

**Figure 32. Load Transient Response in PFM/PWM Operation**



$V_O = 1.2\text{ V}$   $V_I = 2.7\text{ V}$  MODE = Low

**Figure 33. Load Transient Response in PFM/PWM Operation**



$V_O = 1.2\text{ V}$   $V_I = 4.5\text{ V}$  MODE = Low

**Figure 34. Load Transient Response in PFM/PWM Operation**

## Typical Application (continued)

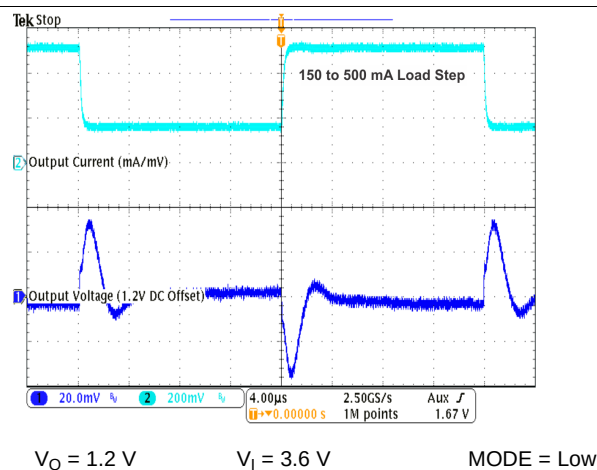


Figure 35. Load Transient Response in PFM/PWM Operation

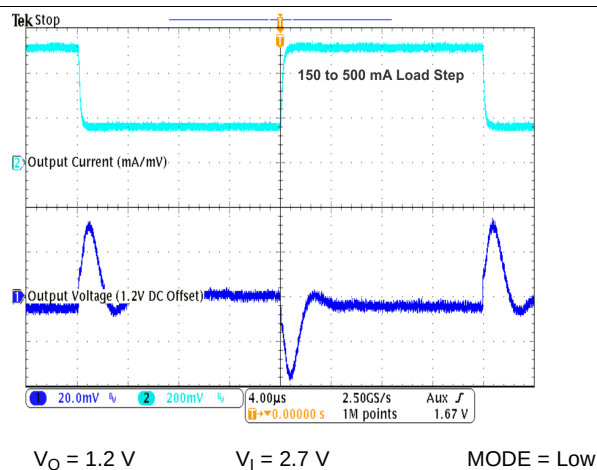


Figure 36. Load Transient Response in PFM/PWM Operation

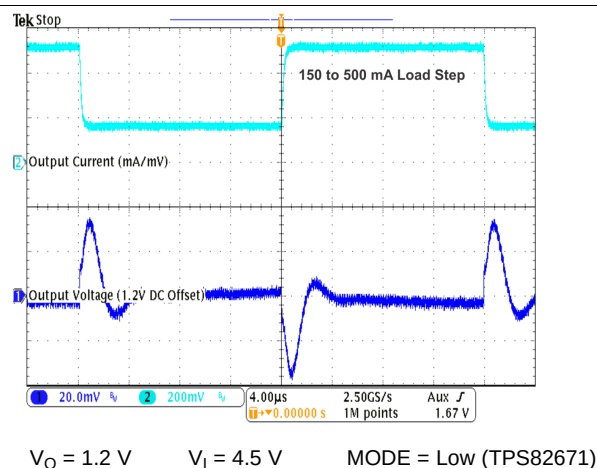


Figure 37. Load Transient Response in PFM/PWM Operation

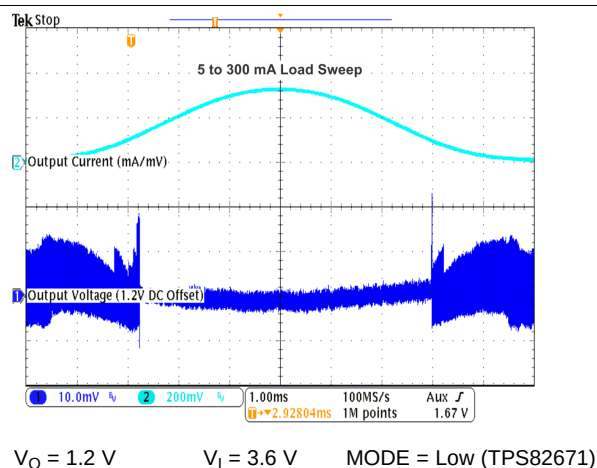


Figure 38. AC Load Transient Response

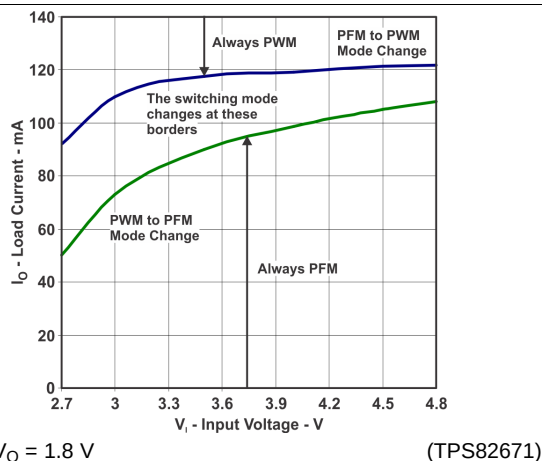


Figure 39. PFM/PWM Boundaries

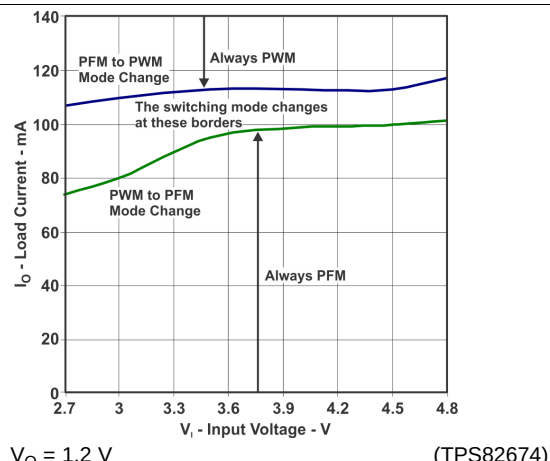


Figure 40. PFM/PWM Boundaries

## Typical Application (continued)

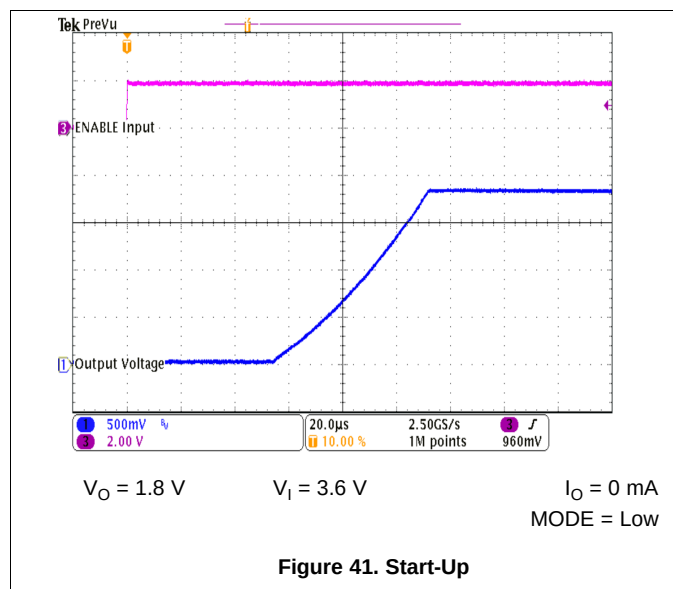


Figure 41. Start-Up

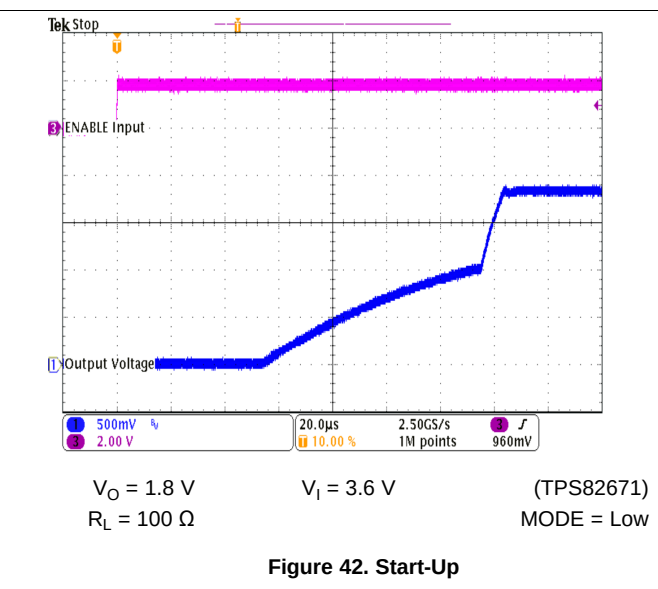


Figure 42. Start-Up

## 11 Power Supply Recommendations

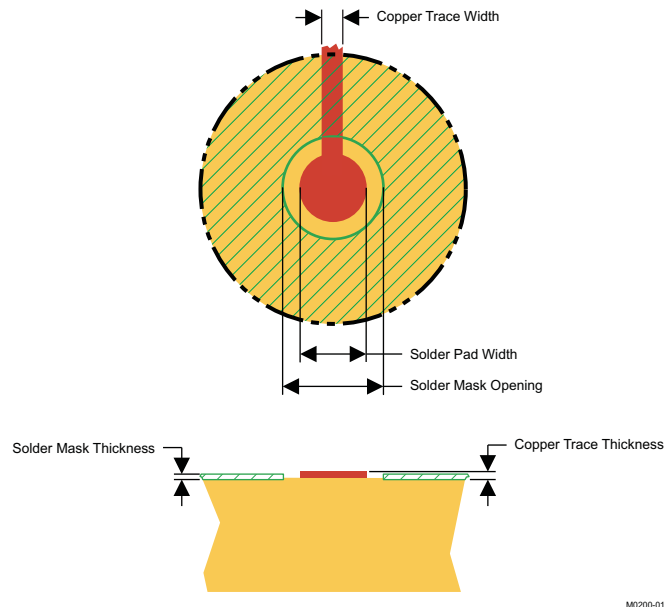
The TPS8267X devices are designed to operate from a 2.3-V to 4.8-V input voltage supply. The input power supply's output current needs to be rated according to the output voltage and the output current of the power rail application.

## 12 Layout

### 12.1 Layout Guidelines

In making the pad size for the  $\mu$ SiP LGA balls, it is recommended that the layout use non-solder-mask defined (NSMD) land. With this method, the solder mask opening is made larger than the desired land area, and the opening size is defined by the copper pad width. Figure 43 shows the appropriate diameters for a MicroSiP™ layout.

### 12.2 Layout Example



**Figure 43. Recommended Land Pattern Image And Dimensions**

| SOLDER PAD DEFINITIONS <sup>(1)(2)(3)(4)</sup> | COPPER PAD | SOLDER MASK <sup>(5)</sup> OPENING | COPPER THICKNESS  | STENCIL <sup>(6)</sup> OPENING | STENCIL THICKNESS |
|------------------------------------------------|------------|------------------------------------|-------------------|--------------------------------|-------------------|
| Non-solder-mask defined (NSMD)                 | 0.30mm     | 0.360mm                            | 1oz max (0.032mm) | 0.34mm diameter                | 0.1mm thick       |

- (1) Circuit traces from non-solder-mask defined PWB lands should be 75  $\mu$ m to 100  $\mu$ m wide in the exposed area inside the solder mask opening. Wider trace widths reduce device stand off and affect reliability.
- (2) Best reliability results are achieved when the PWB laminate glass transition temperature is above the operating the range of the intended application.
- (3) Recommend solder paste is Type 3 or Type 4.
- (4) For a PWB using a Ni/Au surface finish, the gold thickness should be less than 0.5  $\mu$ m to avoid a reduction in thermal fatigue performance.
- (5) Solder mask thickness should be less than 20  $\mu$ m on top of the copper circuit pattern.
- (6) For best solder stencil performance use laser cut stencils with electro polishing. Chemically etched stencils give inferior solder paste volume control.

### 12.3 Surface Mount Information

The TPS8267x MicroSiP™ DC/DC converter uses an open frame construction that is designed for a fully automated assembly process and that features a large surface area for pick and place operations. See the "Pick Area" in the package drawings.

Package height and weight have been kept to a minimum thereby to allow the MicroSiP™ device to be handled similarly to a 0805 component.

See JEDEC/IPC standard J-STD-20b for reflow recommendations.

## 13 Device and Documentation Support

### 13.1 Documentation Support

#### 13.1.1 References

"EMI Reduction in Switched Power Converters Using Frequency Modulation Techniques", in *IEEE TRANSACTIONS ON ELECTROMAGNETIC COMPATIBILITY*, VOL. 4, NO. 3, AUGUST 2005, pp 569-576 by Josep Balcells, Alfonso Santolaria, Antonio Orlandi, David González, Javier Gago.

### 13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 1. Related Links**

| PARTS      | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| TPS82670   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82671   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82672   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82673   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82674   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82675   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82676   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS82677   | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS826711  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS826716  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS826721  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS826745  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS826765  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TPS8267195 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 13.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 13.4 Trademarks

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Bluetooth is a trademark of Bluetooth SIG, Inc.  
All other trademarks are the property of their respective owners.

### 13.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 13.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS82670SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | YK<br>TXI670        |
| TPS82670SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | YK<br>TXI670        |
| TPS82670SIPR.B                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | YK<br>TXI670        |
| <a href="#">TPS82670SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | YK                  |
| TPS82670SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | YK                  |
| <a href="#">TPS826711SIPR</a> | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | YW                  |
| TPS826711SIPR.A               | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | YW                  |
| <a href="#">TPS826711SIPT</a> | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | YW                  |
| TPS826711SIPT.A               | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | YW                  |
| <a href="#">TPS826716SIPR</a> | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | GS                  |
| TPS826716SIPR.A               | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | GS                  |
| <a href="#">TPS826716SIPT</a> | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | GS                  |
| TPS826716SIPT.A               | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | GS                  |
| <a href="#">TPS82671SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | RA                  |
| TPS82671SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | RA                  |
| <a href="#">TPS82671SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | RA                  |
| TPS82671SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | RA                  |
| <a href="#">TPS826721SIPR</a> | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | EO                  |
| TPS826721SIPR.A               | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | EO                  |
| <a href="#">TPS826721SIPT</a> | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | EO                  |
| TPS826721SIPT.A               | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | EO                  |
| <a href="#">TPS82672SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | WD                  |
| TPS82672SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | WD                  |
| <a href="#">TPS82672SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | WD                  |
| TPS82672SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | WD                  |
| <a href="#">TPS82673SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | YL                  |
| TPS82673SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | YL                  |



| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS82673SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | YL                  |
| TPS82673SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | YL                  |
| <a href="#">TPS826745SIPR</a> | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | B5                  |
| TPS826745SIPR.A               | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | B5                  |
| <a href="#">TPS826745SIPT</a> | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | B5                  |
| TPS826745SIPT.A               | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | B5                  |
| <a href="#">TPS82674SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | SW                  |
| TPS82674SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | SW                  |
| <a href="#">TPS82674SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | SW                  |
| TPS82674SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | SW                  |
| <a href="#">TPS82675SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | RB                  |
| TPS82675SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | RB                  |
| <a href="#">TPS82675SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | RB                  |
| TPS82675SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | RB                  |
| <a href="#">TPS826765SIPR</a> | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | AN                  |
| TPS826765SIPR.A               | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | AN                  |
| <a href="#">TPS826765SIPT</a> | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           |                                      |                                   | -40 to 85    | AN                  |
| TPS826765SIPT.A               | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | AN                  |
| <a href="#">TPS82676SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           |                                      |                                   | -40 to 85    | TU                  |
| TPS82676SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | TU                  |
| <a href="#">TPS82676SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | TU                  |
| TPS82676SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | TU                  |
| <a href="#">TPS82677SIPR</a>  | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 85    | SK                  |
| TPS82677SIPR.A                | Active        | Production           | uSiP (SIP)   8 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   | SK                  |
| <a href="#">TPS82677SIPT</a>  | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 85    | SK                  |
| TPS82677SIPT.A                | Active        | Production           | uSiP (SIP)   8 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   | SK                  |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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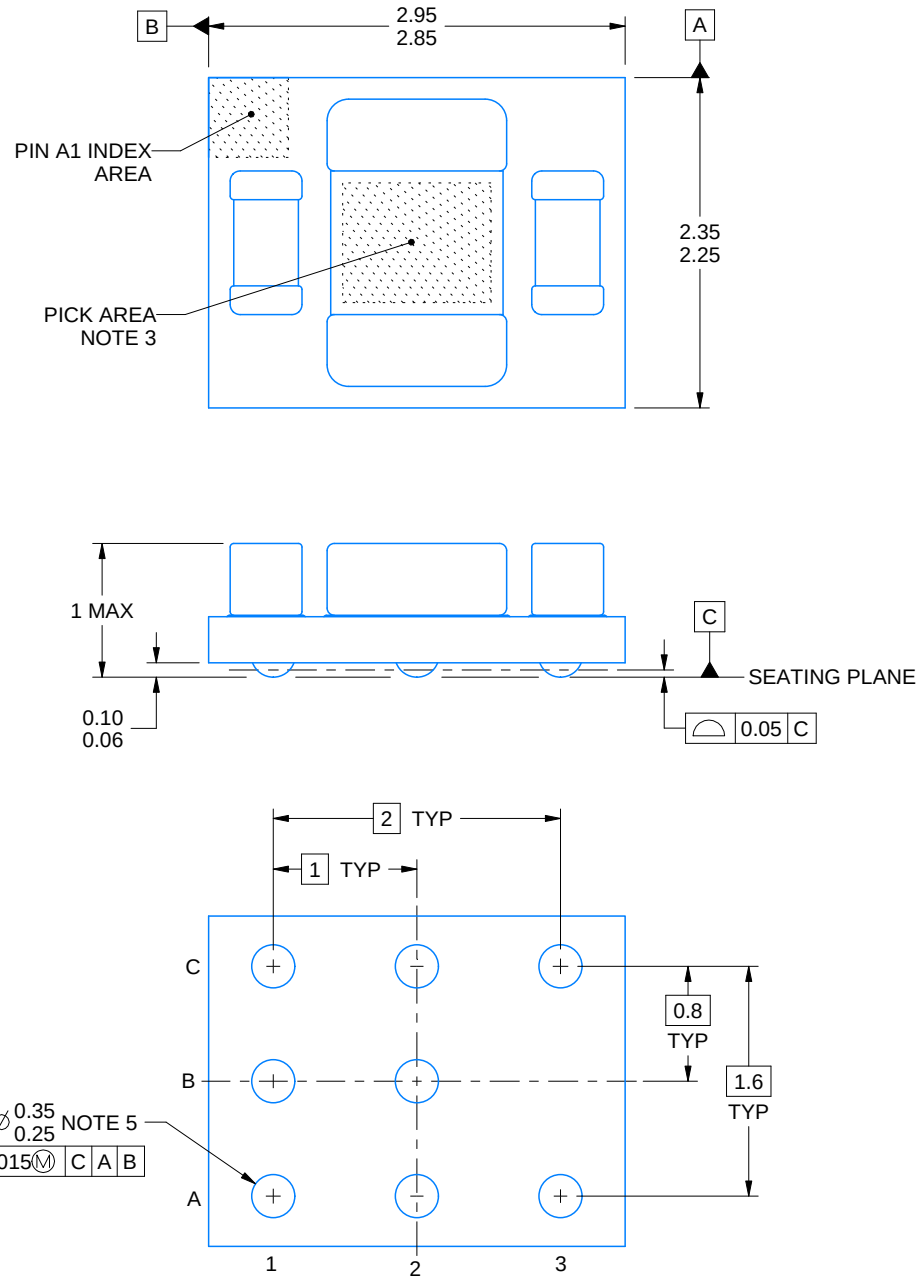


**SIP0008A**

# PACKAGE OUTLINE

**MicroSiP™ - 1 mm max height**

MICRO SYSTEM IN PACKAGE



4220326/A 02/2025

MicroSiP is a trademark of Texas Instruments.

## NOTES:

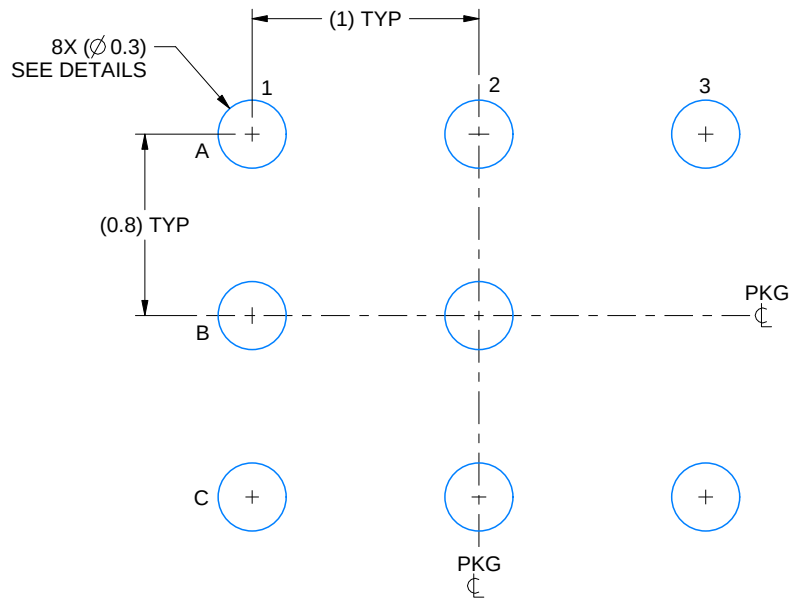
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. For pick and place nozzle recommendation, see product datasheet.
4. Location, size and quantity of each component are for reference only and may vary.
5. This package contains Pb-free balls.

# EXAMPLE BOARD LAYOUT

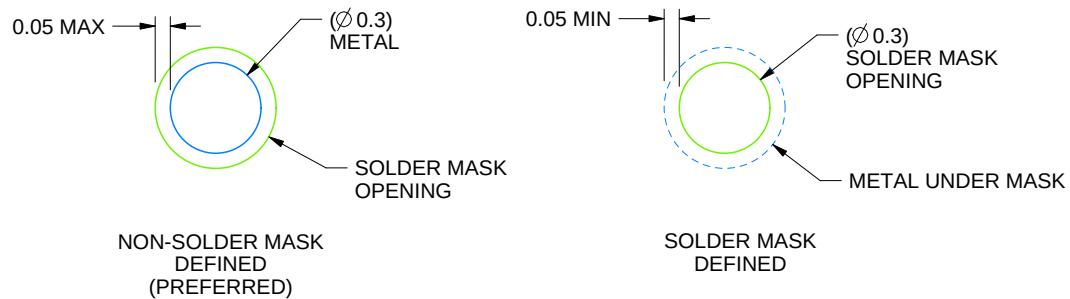
SIP0008A

MicroSiP™ - 1 mm max height

MICRO SYSTEM IN PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 30X

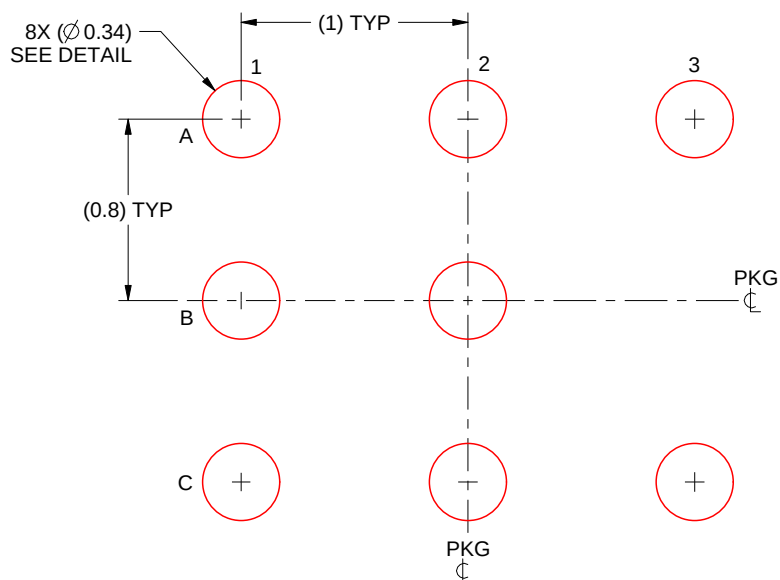


SOLDER MASK DETAILS  
NOT TO SCALE

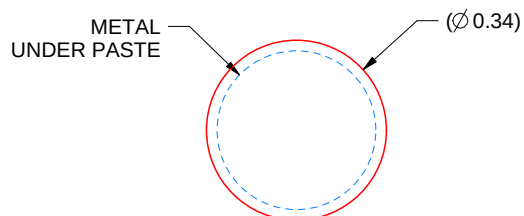
4220326/A 02/2025

NOTES: (continued)

6. For more information, see Texas Instruments literature number SBVA017 ([www.ti.com/lit/sbva017](http://www.ti.com/lit/sbva017)).



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X



SOLDER PASTE DETAIL  
TYPICAL

4220326/A 02/2025

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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